

Intel® 8th-Gen Coffee Lake Core™ i7 / i5 / i3 Fanless Computer med 2xGbE-porte, TPM-understøttelse Lavprofil Chassis

FEATURES

- Intel® 8th-Gen Core™ i hexakern 35W / 65W LGA1151 CPU
- Max. 64 GB RAM
- Intel Q370 Chipset
- Intel UHD 620 Graphics
- XLow-profil chassis med 2,5 "HDD / SSD skuffe med robust, 4x COM port (2x RS232, 2x RS232 / 422/485)
- 2x GigE-porte, der understøtter 9,5 KB jumbo-ramme
- M.2 2280 M-stik (Gen3 x4) understøtter NVMe SSD eller Intel® Optane™ -hukommelse
- 4x USB 3.1 Gen2-porte og 4x USB 3.1 Gen1-porte
- VGA / DVI / DP tredobbelt uafhængig display, der understøtter 4K2K opløsningsopløsning
- Temperaturområde fra -25 ° C til 70 ° C fanless operation



SPECIFICATIONS

CPU	:	Supporting Intel® 8th-Gen Coffee Lake 6-core CPU (LGA1151 socket, 35W/ 65W TDP) - Intel® Core™ i7-8700/ i7-8700T - Intel® Core™ i5-8500/ i5-8500T - Intel® Core™ i3-8100/ i3-8100T - Intel® Pentium® G5400/ G5400T - Intel® Celeron® G4900/ G4900T
Storage	:	1x front-accessible, hot-swappable 2.5" HDD/SSD tray 1x internal SATA port for 2.5" HDD/SSD installation, supporting RAID 0/ 1
Chipset	:	Intel® Q370 Platform Controller Hub
Digital I/O	:	Optional ! NON IN STANDAR DELIVERY !!
USB	:	4x USB 3.1 Gen2 (10 Gbps) ports 4x USB 3.1 Gen1 (5 Gbps) ports
Driftstemperatur	:	with 35W CPU -25°C ~ 70°C ** with 65W CPU -25°C ~ 70°C */** (configured as 35W TDP) -25°C ~ 50°C */** (configured as 65W TDP)
Andet	:	AMT Supports AMT 12.0 TPM Supports TPM 2.0
Approval	:	CE/FCC Class A, according to EN 55032 & EN 55024
Chok/Vibration	:	Vibration Operating, MIL-STD-810G, Method 514.6, Category 4 Shock Operating, MIL-STD-810G, Method 516.6, Procedure I, Table 516.6-I
Ethernet	:	2x Gigabit Ethernet ports by I219 and I210
Forsyning	:	1x 3-pin pluggable terminal block for 8~35VDC DC input
Grafik	:	Integrated Intel® UHD Graphics 630



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Luftfugtighed	:	10% ~ 90% , non-condensing
Lyd	:	1x 3.5 mm jack for mic-in and speaker-out
Montering	:	Wall-mounting (standard) or DIN-Rail mounting (optional)
mPCIe	:	1x full-size mini PCI Express socket with internal SIM socket (mux with mSATA)
PoE	:	non
Porte	:	2x software-programmable RS-232/422/485 ports (COM1/ COM2) 2x RS-232 ports (COM3/ COM4)
RAID niveau	:	RAID 0/1
Udgange	:	1x VGA connector, supporting 1920 x 1200 resolution 1x DVI-D connector, supporting 1920 x 1200 resolution 1x DisplayPort connector, supporting 4096 x 2304 resolution
Udvidelser	:	1x M.2 2280 M key socket (PCIe Gen3/ x4) for NVMe SSD or Intel® Optane™ memory installation
Vægt	:	3.1 Kg
Dimensioner	:	240 mm (W) x 225 mm (D) x 79 mm (H)

